



CERAMIC

Bandpass Filter

BFCQ-2872+

50Ω

27.5 to 30.0 GHz

THE BIG DEAL

- Standard small 1008 (2.5mm x 2.0mm) case style
- Low Insertion Loss – Mid band 1.2 dB typical
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (land grid array)
- Surface mountable pick and place standard case style



Generic photo used for illustration purposes only

CASE STYLE: NL1008C-7

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- Satellite Communications

PRODUCT OVERVIEW

The BFCQ-2872+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The typical passband loss at 27.5 –30.0 GHz is as low as 1.2 dB, with typical stopband rejections at 37 dB up to 55 GHz. This model handles up to 1W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis.

KEY FEATURES

Feature	Advantages
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (2.5mm x 2.0mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.





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ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Center Frequency	—	—	—	28.7	—	GHz
Passband	Insertion Loss	F1-F2	27.5 - 30	1.2	3.0	dB
	Return Loss	F1-F2	27.5 - 30	12	—	dB
Stop Band, Lower	Insertion Loss	DC-F3	0.1 - 18	30	47	dB
		18 - 22.2	22	32		
Stop Band, Upper	Insertion Loss	F4-F5	35.3 - 38	20	28.4	dB
		38 - 55	27	37		

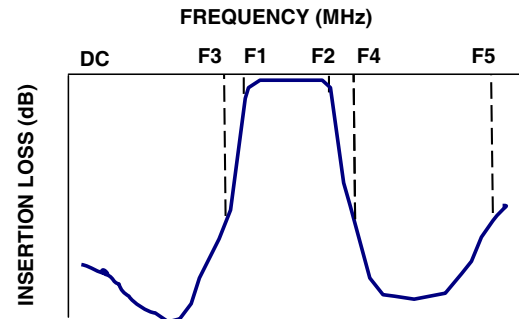
1. Measured on Mini-Circuits Test Board TB-BFCQ-2872C+ with connectors and feedline de-embedded with 2xThru.

MAXIMUM RATINGS

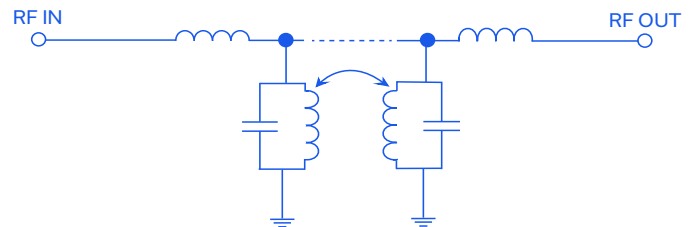
Parameter	Ratings
Operating temperature	-55°C to +125°C
Storage temperature	-55°C to +125°C
RF Power Input	1W

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC





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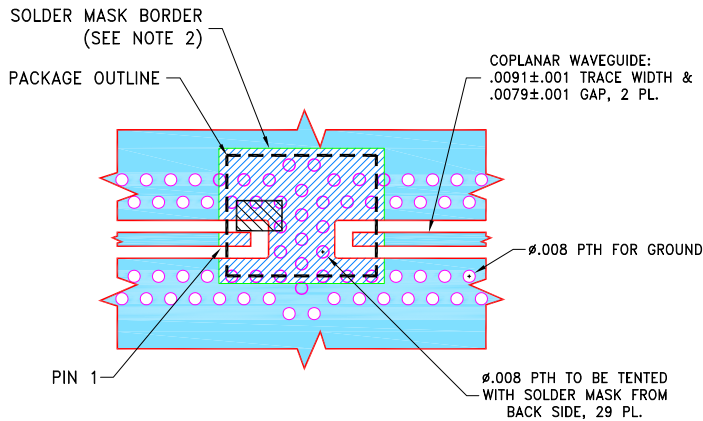
27.5 to 30.0 GHz

PAD CONNECTIONS

INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: UC

DEMO BOARD MCL P/N: TB-BFCQ-2872C+ SUGGESTED PCB LAYOUT (PL-707)

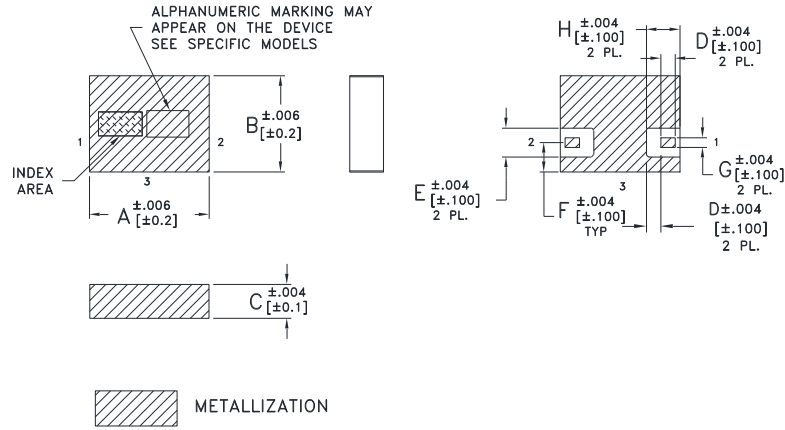


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR MEGTRON-7 R5785(N); DIELECTRIC THICKNESS: .0049±.001; CLOTH STYLE: 2116; COPPER: HVLP/HVLP. FOR OTHER MATERIALS LINE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. SOLDER MASK OPENING FOR COMPONENT SOLDERING HAS BEEN INCREASED AGAINST PCB LAND PATTERN RECOMMENDATIONS PER NL1008C-6 AND CAN BE DEVIATED FROM THIS DRAWING TO COMPLY WITH CUSTOMERS' DESIGN RULES.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DRAWING



OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F	G	H	J	K	wt
.098	.079	.028	.012	.024	.024	.008	.028	.043	.024	grams
2.49	2.01	0.71	0.30	0.61	0.61	0.20	0.71	1.09	0.61	.019



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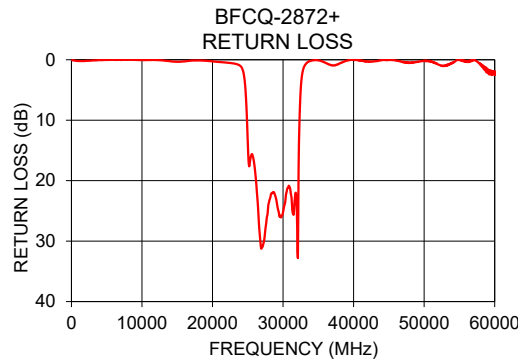
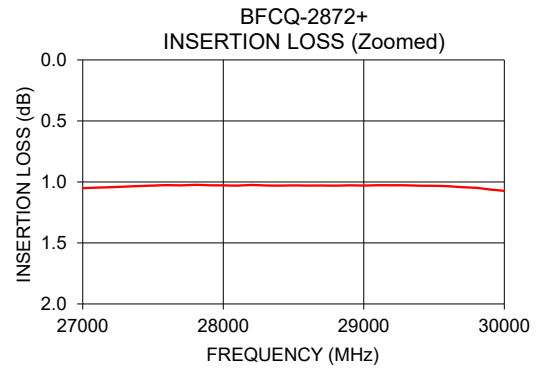
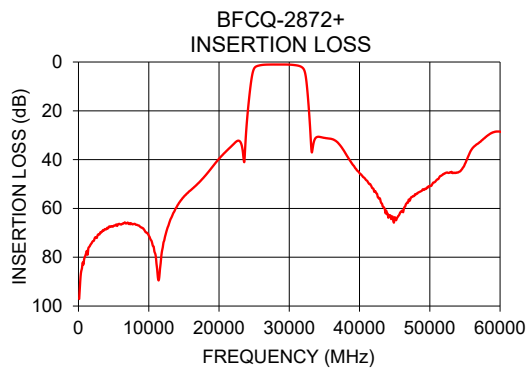
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TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
100	97.10	0.07
3000	70.63	0.11
6000	66.55	0.01
9000	67.80	0.02
12000	75.89	0.05
15000	55.18	0.34
18000	46.72	0.12
22200	33.28	0.50
24000	23.39	1.08
27500	1.03	27.95
28700	1.03	21.91
30000	1.07	25.18
35300	31.23	0.17
38000	37.43	0.59
42000	52.13	0.32
45000	63.65	0.05
48000	54.31	0.53
51000	48.28	0.24
55000	41.74	0.08
60000	28.54	2.52



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

